

# 薛承輝

## 著作目錄

### 期刊論文

1. T. H. Huang and C. H. Hsueh (2022, Mar). Enhanced Mechanical Properties of CoCrFeMnNi High Entropy Alloy Films with Mo Doping. *Advances in Engineering*, <https://advanceseng.com/cocrfemnni-high-entropy-alloy-films-mo-doping/>. 本人為通訊作者.
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### 專書

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